This replaces PIB DK3047.

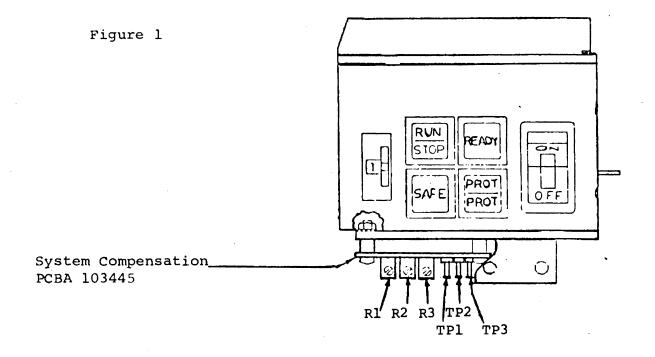
PERIPHERAL EQUIPMENT DIVISION

8/15/76 Rev. B PIB NO.

1	TITLE TEMPERATURE COMPLUNITS FITTED WITH	PIB NO. DK3047.B				
	PRODUCT TAPE [] DISK X LINE: FORMATTER []	NT CHANGED MODEL SERIES AFFECTED 03450 D3000		EFFECTIVE DATE April 5, 1976		
	CLASS OF BULLETIN:	ORDER PAR KIT NO.		CTIVITY ted with Temper-		
	IMPROVEMENT	N/A	ature Compensa	ature Compensation PCBA 103450		
١	RETROFIT ON FAILURE	14/ 77	103445. D3422	and System Compensation PCBA 103445. D342X and D344X up to		
١	RETROFIT RECOMMENDED		serial number	•		
- 1	SERVICE INFORMATION ONLY		This replaces	PIB DK3047.		

PURPOSE:

Earlier versions of the D3000 disk unit, operating at 200 tpi, were fitted with a Temperature Compensation PCBA 103450, fitted alongside the Read/Write PCBA, and a System Compensation PCBA 103445, fitted below the Switch Panel at the front of the unit, as shown in Figure 1.



Should Additional Information Be Required — Contact

DISTRIBUTION CODE: 6318

PERTEC

PERIPHERAL EQUIPMENT DIVISION 9600 Irondale Avenue, Chatsworth, California 91311 Phone (213) 882-0030 / TWX (910) 494-2093 ATTENTION: PRODUCT SUPPORT MANAGER PERTEC 20 K012C(1)



PERIPHERAL EQUIPMENT DIVISION

TITLE

TEMPERATURE COMPENSATION ADJUSTMENT PROCEDURE FOR UNITS FITTED WITH SYSTEM COMPENSATION PCBA

PIB NO. DK3047 B

PURPOSE: (continued)

These PCBAs operate in conjunction with a thermistor mounted adjacent to the positioner, to provide a signal which is proportional to the temperature and offsets the heads accordingly.

This information is not contained in the current D3000 manual.

This bulletin provides the necessary data in the form of test configurations, test procedures and adjustment procedures for the setting up of the Temperature Compensation System, should this be necessary due to the replacement of any of the component parts of the system.

NOTE

All references to test points on the Temperature Compensation PCBA are designated "TCTPX" and are shown in Figure 2; those on the System Compensation PCBA are designated "SCTPX" and are shown in figures 1 and 3.

TEST CONFIGURATION:

- (1) The test disk cartridge must be stored for a minimum of 90 minutes at the same ambient temperature as the disk drive prior to insertion in the disk drive.
- (2) Insert the test disk cartridge.
- (3) Run the disk drive in the READY mode for a minimum of 5 minutes.
- (4) Connect a disk exerciser capable of selecting the upper and lower platters and also capable of positioning the heads to any desired cylinder address.
- (5) Place a temperature probe adjacent to the thermistor.

NOTE:

Temperature measuring equipment should have a range from $68^{\circ}F$ to $87.8^{\circ}F$ (20°C to 31°C) with an error limit not greater than \pm 1°F (\pm 0.5°C).

(6) Using a Digital Voltmeter, connect the positive test lead to TCTP4 on the Temperature Compensation PCBA, and the common test lead to TCTP17 (ground).



PERIPHERAL EQUIPMENT DIVISION

TITLE TEMPERATURE COMPENSATION ADJUSTMENT PROCEDURE FOR UNITS FITTED WITH SYSTEM COMPENSATION PCBA

PIB NO. DK3047 B

TEST PROCEDURE:

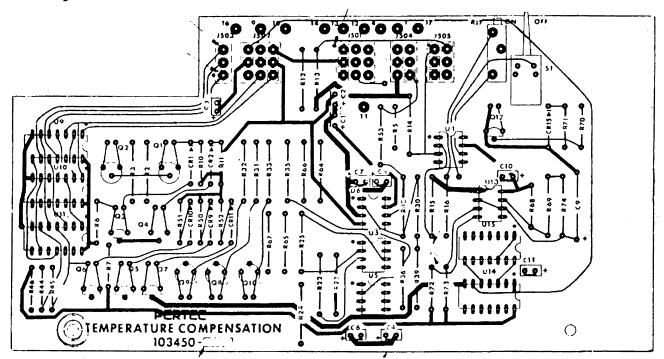
- (1) Establish the test configuration described in previous paragraph.
- (2) Observe the temperature probe reading.
- (3) Position the heads to cylinder addresses (in Table 1) that are within the Temperature range indicated by the observed temperature probe reading.
- (4) Observe the voltage readings at TCTP4 for each cylinder address in Step (3).

NOTE

If any of the voltages in Step (4) are out of tolerance (see Table 1), perform the adjustment procedure in next paragraph.

(5) Proceed with the scaling resistor verification on Page 6.

Figure 2





PERIPHERAL EQUIPMENT DIVISION

		PIB NO.
	TEMPERATURE COMPENSATION ADJUSTMENT PROCEDURE	PIB NO.
		00455
11155	FOR UNITS FITTED WITH SYSTEM COMPENSATION PCBA	DK3047 B

ADJUSTMENT PROCEDURE:

- (1) Note the temperature adjacent to the thermistor.
- (2) Move the DVM positive probe to TCTP1 on the Temperature Compensation PCBA. Maintain the DVM ground lead on TP5.
- (3) Adjust R17 on the PCBA to attain a voltage that corresponds to the temperature noted in Step (1). See Table 2.

TABLE 1

	RATURE	CYLIN	NDER ADDRESS	TCTP4 VOLTAGE	
°C	\circ_{F}				
20	68		(100 octal)	+0.432 ± 0.100V	7
20	68	128	(200 octal)	+0.217 "	
20	- 68	256	(400 octal)	-0.204 "	
21	69.8	64	(100 octal)	+0.346 "	
21	69.8		(200 octal) + 0.17		
21	69.8		(400 octal)	-0.163 "	
22	71.6	64	(100 octal)	+0.260 "	
22	71.6		(200 octal)	+0.131 "	
22	71.6		(400 octal)	-0.122 "	
23	73.4	64	(100 octal)	+0.174 "	
23	73.4		(200 octal)	+0.088 "	
23	73.4		(400 octal)	-0.081 "	
24	75.2	64	(100 octal)	# 0.080 "to.0	88
24	75.2	128	(200 octal)	+0.045 "	
24	75.2	256	(400 octal)	040 "	
25	77.0	64	(100 octal)	.000 "	
25	77.0		(200 octal)	.000 "	
25	77.0		(400 octal)	.000 "	
26	78.8	64	(100 octal)	= .88 0 "-0.4	188
26	78.8	128	(200 octal)	045 "	
			(#UU UCCAI)	045 "	
26	78.8		(400 octal)	+ .040 "	
	78.8	256	•	045	
26 27 27		256 64	(400 octal)	+ .040 "	
27	78.8 80.6	256 64 128	(400 octal) (100 octal)	+ .040 " -0.174 "	
27 27 27	78.8 80.6 80.6 80.6	256 64 128 256	(400 octal) (100 octal) (200 octal)	+ .045 + .040 " -0.174 " -0.088 "	
27 27	78.8 80.6 80.6	256 64 128 256 64	(400 octal) (100 octal) (200 octal) (400 octal)	+ .040 " -0.174 " -0.088 " +0.081 "	
27 27 27 28	78.8 80.6 80.6 80.6	256 64 128 256 64 128	(400 octal) (100 octal) (200 octal) (400 octal) (100 octal)	+ .040 " -0.174 " -0.088 " +0.081 " -0.260 "	



PERIPHERAL EQUIPMENT DIVISION

TITLE	TEM	PERATU	RE COMPI	ENSATI	CON ADJ	JS TMENT COMPENS	PROCEI	OURE	Ì
111111	FOR	UNITS	FITTED	WITH	SYSTEM	COMPENS	NOITA	PCBA	

PIB NO. DK3047 B

TABLE 1 continued

TEMPER	RATURE	CYLINDER	ADDRESS	TCTP4 VOLTAGE
°C	O _F			
29	84.2	64 (100	octal)	-0.346 ± 0.100V
29	84.2	128 (200	octal) - 0.174	-0.017 "
29	84.2	256 (400	octal)	+0.163 "
30	86.0	64 (100	octal)	-0.432 "
30	86.0	128 (200	octal)	-0.217 "
30	86.0	256 (400	octal)	+0.204 "
31	87.8	64 (100	octal)	-0.518 "
31	87.8		octal) -0.260	
31	87.8	256 (400	octal) + 0.245	-6-845 "
32	89.6	64 (100	octal)	-0.286 "-0.604
32	89.6	128 (200	octal)	-0.305 "
32	89.6	256 (400	octal)	+0.286 "
33	91.4	64 (100	octal)	-0.690 "
33	91.4	128 (200	octal)	-0.348 "
33	91.4	256 (400	octal)	+0.327 "
34	93.2	64 (100	octal)	-0.778 "
34	93.2	128 (200	octal)	-0.391 "
34	93.2	256 (400	octal)	+0.368 "
35	95.0	64 (100	octal)	-0.864 "
35	95.0	128 (200	octal)	-0.434 "
35	95.0	256 (400	octal)	+0.409 "

TABLE 2

TEMPE	RATURE	TCTP1 VOLTAGE			
°C	\circ_{F}				
22.0	71.6	+2.898 to +2.954V			
23.0	73.4	+2.970 to +3.030V			
24.0	75.2	+3.044 to +3.106V			
25.0	77.0	+3.118 to +3.182V			
26.0	78.8	+3.198 to +3.262V			
27.0	80.6	+3.277 to +3.343V			
28.0	82.4	+3.361 to +3.429V			
29.0	84.2	+3.440 to +3.510V			
30.0	86.0	+3.514 to +3.586V			
31.0	87.8	+3.604 to +3.676V			



PERIPHERAL EQUIPMENT DIVISION

TITLE TEMPERATURE COMPENSATION ADJUSTMENT PROCEDURE FOR UNITS FITTED WITH SYSTEM COMPENSATION PCBA

PIB NO. DK3047 B

SCALING RESISTOR VERIFICATION:

- (1) Move the DVM positive probe to TCTP12 on the Temperature Compensation PCBA. (SCTP3 on the System Compensation PCBA.)
- (2) Adjust R3 on the System Compensation PCBA to +1.0V.
- (3) Move the DVM positive probe to TCTP4 on the Temperature Compensation PCBA.
- (4) Using the disk exerciser, refer to Table 3 and check that the voltage at TCTP4 is within the range specified for each of the cylinder addresses listed.

NOTE

If the voltages on TCTP4 are not within limits for each cylinder address in Step (4), there may be a component failure in the scaling resistor and/or the cylinder address circuitry.

(5) Proceed with the environment temperature adjustment.

TABLE 3

CYLINDER ADDRESS	TCTP4 VOLTAGE
32 (40 octal)	+1.49 to +1.82V
96 (140 octal)	+0.98 to $+1.20$ V
160 (240 octal)	+0.50 to +0.61V
224 (340 octal)	-0.07 to +0.05V
288 (440 octal)	-0.51 to -0.41 V
352 (540 octal)	-1.12 to -0.92V
400 (620 octal)	-1.72 to -1.40 V

ENVIRONMENT TEMPERATURE ADJUSTMENT:

NOTE

Location of the heads is not relevant to this adjustment.

- (1) Note the temperature reading on the probe adjacent to the thermistor.
- (2) Move the DVM positive probe to TCTP12 on the Temperature Compensation PCBA. (SCTP3 on the System Compensation PCBA).



PERIPHERAL EQUIPMENT DIVISION

TITLE

TEMPERATURE COMPENSATION ADJUSTMENT PROCEDURE FOR UNITS FITTED WITH SYSTEM COMPENSATION PCBA

PIB NO. DK3047 B

ENVIRONMENT TEMPERATURE ADJUSTMENT (continued):

- (3) Adjust R3 on the System Compensation PCBA to the voltage (Table 4) corresponding to the temperature reading observed in Step (1).
- (4) Remove DVM positive probe from TCTP12 (SCTP3).
- (5) Remove DVM negative probe from TCTP17.
- (6) Remove Disk exerciser.
- (7) Deenergize disk drive.

TABLE 4

	TEMPERATURE	TCTP12	(SCTP3)	VOLTAGE
°C	$\circ_{_{ m F}}$			
20	68.0		+0.40V	
21	69.8		+0.32V	
22	71.6		+0.24V	
23	73.4		+0.16V	
24	75.2		+0.08V	
25	77.0		+0.00V	
26	78.8		-0.08V	
27	80.6		-0.16V	
28	82.4		-0.24V	
29	84.2		-0.32V	
30	86.0		-0.40V	
31	87.8		-0.48V	
32	89.6		-0.56V	
33	91.4		-0.64V	
34	93.2		-0.72V	
35	95.0		-0.80V	

NOTE

Mechanical CE Alignment (Paragraph 6.13, D3000 manual) must be performed if any temperature compensation adjustments are made. R1, R2, SCTP1 and SCTP2 on the System Compensation PCBA are used in the CE Alignment procedure to provide fine adjustment of the heads. R1 is the potentiometer which provides fine electrical adjustments for the lower head of the removeable platter; R2 provides adjustment of the upper head of this platter. Switch S1 on the Temperature Compensation PCBA should normally be in the ON position, except when the initial radial head alignment is carried out.

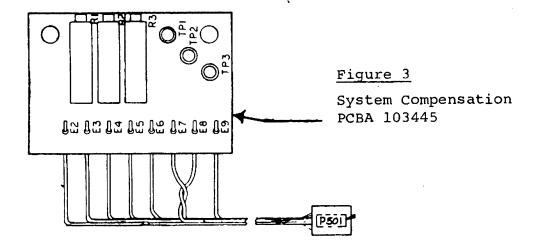
PERTEC

PRODUCT IMPROVEMENT BULLETIN

PERIPHERAL EQUIPMENT DIVISION

TITLE TEMPERATURE COMPENSATION ADJUSTMENT PROCEDURE FOR UNITS FITTED WITH SYSTEM COMPENSATION PCBA

PIB NO. DK3047 B



DRAWING REFERENCES:

Schematic - System Compensation 103444

Assembly - " 10344!

Schematic - Temperature Compensation 103449

Assembly " 103450